

TOSHIBA MOS DIGITAL INTEGRATED CIRCUIT SILICON GATE CMOS

131,072-WORD BY 32-BIT SYNCHRONOUS FLOW THROUGH STATIC RAM

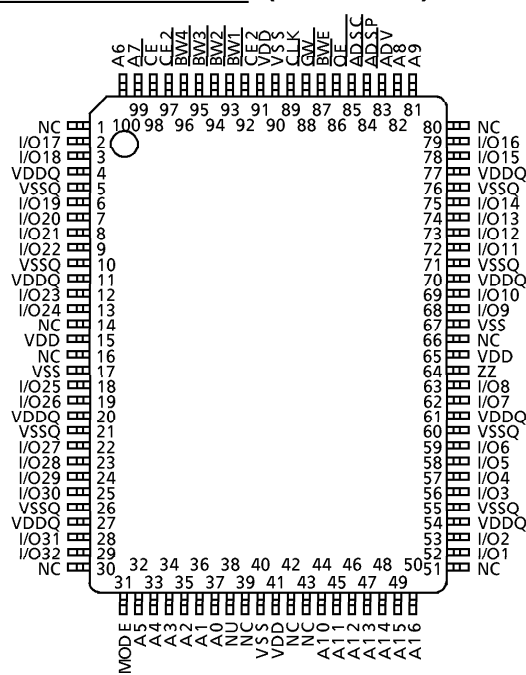
DESCRIPTION

The TC55V4336FFI is a 4,194,304-bit synchronous Flow through static random access memory (SRAM) organized as 131,072 words by 32 bits. It is designed for use as a secondary cache to support microprocessor units equipped with burst functions. A 2-bit burst address counter and control logic is integrated with a 128 K × 32 static RAM. All inputs except output enable OE are synchronized to the rising edge of the CLK input. Read operations are initiated by the ADSP address status processor input or ADSC address status controller input. Subsequent burst addresses can be generated internally under control of the ADV address advance input. Write operations are internally self-timed and are initiated by the rising edge of CLK. Byte write enables (BW1 through BW4) allow one- to four-byte write operations to be performed. It guarantees -40° to 85°C operating temperature so it is suitable for use in wide operating temperature system. The TC55V4336FFI uses dual power supplies (3.3 V for core and 3.3 V/2.5 V for output buffer) and is available in a low-profile 100-pin plastic QFP (LQFP).

FEATURES

- Organization as 128K words by 32 bits.
- Fast cycle time of 12ns per minimum (83MHz maximum)
- Fast access time of 9ns maximum (from clock edge to data output)
- Flow through operation
- 2-bit burst address counter (interleaved or linear burst sequences)
- Synchronous self-timed write (global write or byte write)
- Stop-clock mode for power down
- Snooze mode pin(ZZ) for power down
- LVTTTL compatible interface
- Dual power supply (3.3V for core and 3.3 V/2.5V for output buffer)
- Operating temperature range : -40° to 85°C
- Available in 100-pin LQFP package(LQFP100-P-1420-0.65K:0.65mm pitch, 1.6mm height, typically 0.56 grams)

PIN ASSIGNMENT (TOP VIEW)



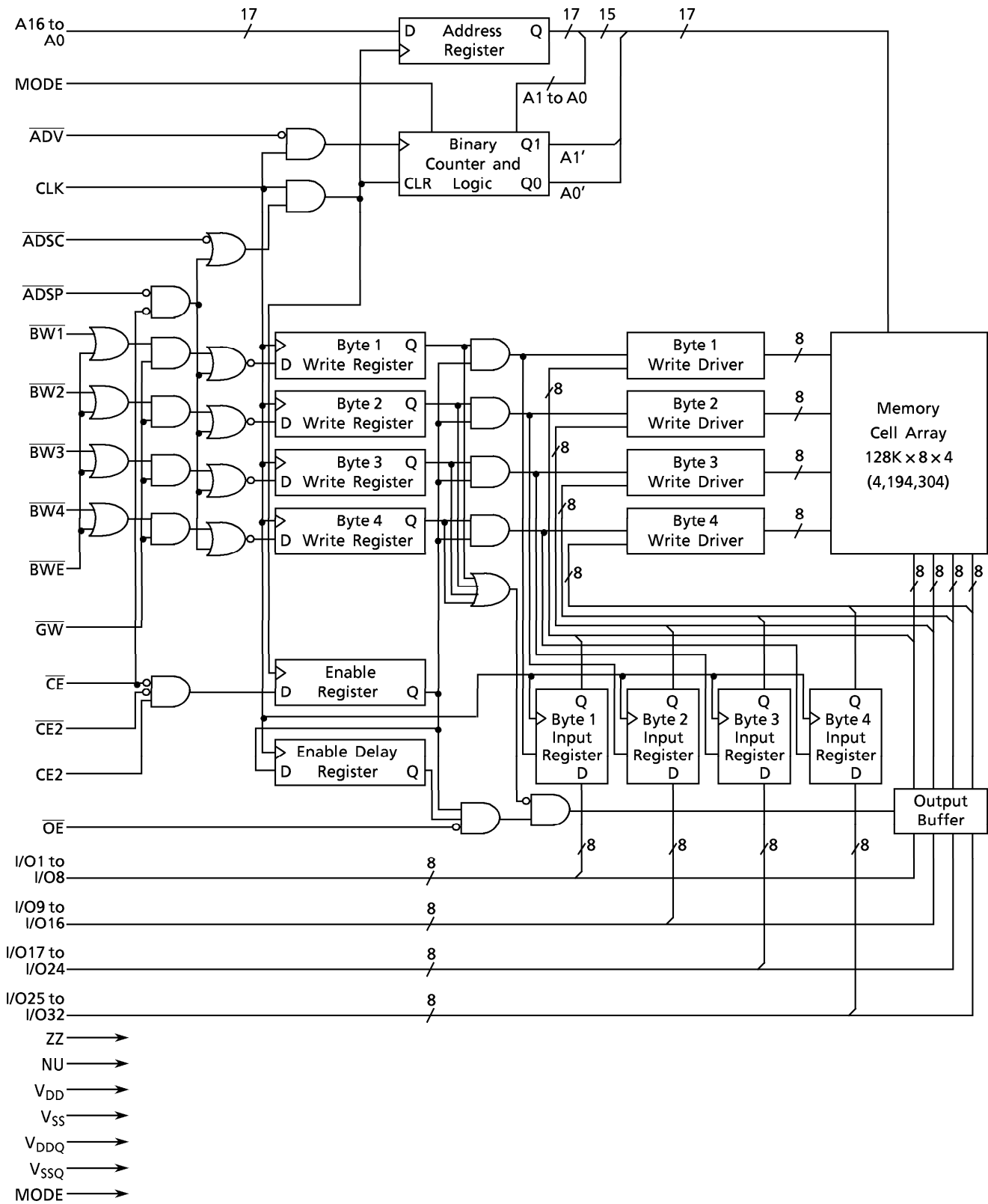
PIN NAMES

|                  |                                 |
|------------------|---------------------------------|
| A0 to A16        | Address Inputs                  |
| I/O1 to I/O32    | Data Inputs/Outputs             |
| CLK              | Clock Input                     |
| CE, CE2, CE2     | Chip Enable                     |
| ADSP             | Address Status Processor Input  |
| ADSC             | Address Status Controller Input |
| ADV              | Address Advance Input           |
| GW               | Global Write Enable Input       |
| BWE              | Byte Write Enable Input         |
| BW1 to BW4       | Byte Write Enable Inputs        |
| OE               | Output Enable                   |
| MODE             | Mode Select Input               |
| ZZ               | Snooze Input                    |
| NU               | Not Usable Input                |
| V <sub>DD</sub>  | Power Supply for Core           |
| V <sub>SS</sub>  | Ground for Core                 |
| V <sub>DDQ</sub> | Power Supply for Output Buffer  |
| V <sub>SSQ</sub> | Ground for Output Buffer        |
| NC               | No Connection                   |

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BLOCK DIAGRAM



PIN DESCRIPTIONS

| PIN NUMBER                                                          | SYMBOL                                                                    | TYPE                | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|---------------------------------------------------------------------|---------------------------------------------------------------------------|---------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 37, 36, 35, 34, 33, 32, 100, 99, 82, 81, 44, 45, 46, 47, 48, 49, 50 | A0 to A16                                                                 | Input (synchronous) | <b>Synchronous Address Inputs</b><br>Registered on the rising edge of CLK. Address inputs must meet the specified setup and hold times with respect to the CLK rising edge when the chip is enabled.                                                                                                                                                                                                                                                                                                                    |
| 93, 94, 95, 96                                                      | $\overline{BW1}$ , $\overline{BW2}$ , $\overline{BW3}$ , $\overline{BW4}$ | Input (synchronous) | <b>Synchronous Byte Write Enables</b><br>These active low inputs control byte write operations when $\overline{BWE}$ is low. $\overline{BW1}$ controls I/O1 through I/O8. $\overline{BW2}$ controls I/O9 through I/O16. $\overline{BW3}$ controls I/O17 through I/O24. $\overline{BW4}$ controls I/O25 through I/O32. For byte write operations, when any of these four inputs go Low, all outputs go to high impedance.                                                                                                |
| 87                                                                  | $\overline{BWE}$                                                          | Input (synchronous) | <b>Synchronous Byte Write Enable</b><br>This active low input controls byte write operations.                                                                                                                                                                                                                                                                                                                                                                                                                           |
| 88                                                                  | $\overline{GW}$                                                           | Input (synchronous) | <b>Synchronous Global Write</b><br>This active low input controls 32-bit write operations independent of the $\overline{BWE}$ and $\overline{BW1}$ to $\overline{BW4}$ inputs.                                                                                                                                                                                                                                                                                                                                          |
| 89                                                                  | CLK                                                                       | Input               | <b>Reference Clock</b><br>All synchronous input signals are registered on the rising edge of CLK. Synchronous signal timings are measured from the rising edge of CLK. Synchronous input signals must meet the specified setup and hold times with respect to the rising edge of CLK.                                                                                                                                                                                                                                   |
| 83                                                                  | $\overline{ADV}$                                                          | Input (synchronous) | <b>Synchronous Burst Advance</b><br>This active low signal controls the internal burst address counter after an external address has been loaded. When Low, the internal burst address is advanced. When High, the internal burst address is not advanced. If a write operation initiated by $\overline{ADSP}$ is desired, this signal must be High to write the loaded address on the rising edge of the first clock after the assertion of $\overline{ADSP}$ .                                                        |
| 84                                                                  | $\overline{ADSP}$                                                         | Input (synchronous) | <b>Synchronous Address Status Processor</b><br>This active low signal controls the burst start by registering a new external address. The write enables ( $\overline{GW}$ , $\overline{BWE}$ , $\overline{BW1}$ to $\overline{BW4}$ ) are ignored at the assertion of $\overline{ADSP}$ and a read operation is initiated. Subsequent operations are dependent on the write enables at the rising edge of the first clock after the assertion of $\overline{ADSP}$ . This signal is ignored if $\overline{CE}$ is High. |

| PIN NUMBER                                                                                                                           | SYMBOL                   | TYPE                            | DESCRIPTION                                                                                                                                                                                                                                                                                                                                 |
|--------------------------------------------------------------------------------------------------------------------------------------|--------------------------|---------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 85                                                                                                                                   | $\overline{\text{ADSC}}$ | Input<br>(synchronous)          | <b>Synchronous Address Status Controller</b><br>This active low signal initiates a burst read or write, depending on the write enables ( $\overline{\text{GW}}$ , $\overline{\text{BWE}}$ , $\overline{\text{BW1}}$ to $\overline{\text{BW4}}$ ), by registering a new external address.                                                    |
| 98                                                                                                                                   | $\overline{\text{CE}}$   | Input<br>(synchronous)          | <b>Synchronous Chip Enable</b><br>This active low signal controls the chip status (enable or disable) and the internal use of $\overline{\text{ADSP}}$ . It is sampled only when a new external address is loaded.                                                                                                                          |
| 92                                                                                                                                   | $\overline{\text{CE2}}$  | Input<br>(synchronous)          | <b>Synchronous Chip Enable</b><br>This active low signal controls the chip status (enable or disable). It is sampled only when a new external address is loaded. It can be used for memory expansion.                                                                                                                                       |
| 97                                                                                                                                   | $\text{CE2}$             | Input<br>(synchronous)          | <b>Synchronous Chip Enable</b><br>This active high signal controls the chip status (enable or disable). It is sampled only when a new external address is loaded. It can be used for memory expansion.                                                                                                                                      |
| 86                                                                                                                                   | $\overline{\text{OE}}$   | Input<br>(asynchronous)         | <b>Asynchronous Output Enable</b><br>This active low signal controls all 32-bit I/O output buffers. It must be high while write data is being driven prior to the assertion of the byte write enables ( $\overline{\text{GW}}$ , $\overline{\text{BWE}}$ , $\overline{\text{BW1}}$ to $\overline{\text{BW4}}$ ) following a read operation. |
| 52, 53, 56, 57, 58, 59,<br>62, 63, 68, 69, 72, 73,<br>74, 75, 78, 79, 2, 3, 6,<br>7, 8, 9, 12, 13, 18, 19,<br>22, 23, 24, 25, 28, 29 | I/O1 to I/O32            | Input / Output<br>(synchronous) | <b>Synchronous Data Inputs/Outputs</b><br>Byte1 is I/O1 to I/O8, Byte2 is I/O9 to I/O16,<br>Byte3 is I/O17 to I/O24, Byte4 is I/O25 to I/O32.                                                                                                                                                                                               |
| 31                                                                                                                                   | MODE                     | Input<br>(asynchronous)         | <b>Mode Select</b><br>This signal selects the burst sequence. If High or not connected, the burst sequence defaults to Interleaved Burst. If Low, the burst sequence is Linear Burst.<br>This input is pulled up internally. Do not alter the input state while the device is operating.                                                    |

| PIN NUMBER                               | SYMBOL    | TYPE                    | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
|------------------------------------------|-----------|-------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 64                                       | ZZ        | Input<br>(asynchronous) | <b>Snooze</b><br>This active high signal is used to place the device into sleep mode (low power standby mode). When Low or not connected, the device remains in the active state. When high, the device goes into a sleep state, and memory data is retained. After this signal is deasserted, the device wakes up when a read or write operation is initiated by $\overline{ADSP}$ or $\overline{ADSC}$ . If ZZ (sleep) mode will not be used, connect this input to $V_{SS}$ . |
| 38                                       | NU        | Input<br>(asynchronous) | <b>Not Usable</b><br>This signal is used only by the manufacturer. This signal must be low or not connected. This input is internally pulled down.                                                                                                                                                                                                                                                                                                                               |
| 1, 14, 16, 30, 39, 42,<br>43, 51, 66, 80 | NC        | —                       | <b>No Connection</b><br>These inputs are not internally connected.                                                                                                                                                                                                                                                                                                                                                                                                               |
| 15, 41, 65, 91                           | $V_{DD}$  | Supply                  | <b>Power Supply</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| 17, 40, 67, 90                           | $V_{SS}$  | Ground                  | <b>Ground</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| 4, 11, 20, 27, 54, 61,<br>70, 77         | $V_{DDQ}$ | Supply                  | <b>Output Buffer Power Supply</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| 5, 10, 21, 26, 55, 60,<br>71, 76         | $V_{SSQ}$ | Ground                  | <b>Output Buffer Ground</b>                                                                                                                                                                                                                                                                                                                                                                                                                                                      |

## OPERATING MODE

(1) Synchronous Input Truth Table

| OPERATION            | CLK   | $\overline{CE}$ | $\overline{CE2}$ | CE2 | $\overline{ADSP}$ | $\overline{ADSC}$ | $\overline{ADV}$ | $\overline{WRITE}$ <sup>4</sup> | ZZ <sup>1</sup> | ADDRESS USED          | I/O <sup>5</sup> | CURRENT <sup>2</sup> |
|----------------------|-------|-----------------|------------------|-----|-------------------|-------------------|------------------|---------------------------------|-----------------|-----------------------|------------------|----------------------|
| Begin Burst Read     | L → H | L               | L                | H   | L                 | x                 | x                | x                               | L               | External Address      | Dout (p)         | I <sub>DDO1</sub>    |
|                      | L → H | L               | L                | H   | H                 | L                 | x                | H                               | L               |                       |                  |                      |
| Continue Burst Read  | L → H | x               | x                | x   | H                 | H                 | L                | H                               | L               | Next Burst Address    | Dout (p)         | I <sub>DDO1</sub>    |
|                      | L → H | H               | x                | x   | L <sup>6</sup>    | H                 | L                | H                               | L               |                       |                  |                      |
| Suspend Burst Read   | L → H | x               | x                | x   | H                 | H                 | H                | H                               | L               | Current Burst Address | Dout (p)         | I <sub>DDO2</sub>    |
|                      | L → H | H               | x                | x   | L <sup>6</sup>    | H                 | H                | H                               | L               |                       |                  |                      |
| Begin Burst Write    | L → H | L               | L                | H   | H                 | L                 | x                | L                               | L               | External Address      | Din (p)          | N/A                  |
|                      | L → H | x               | x                | x   | H                 | H                 | H                | L                               | L               | Current Burst Address |                  |                      |
|                      | L → H | H               | x                | x   | L <sup>6</sup>    | H                 | H                | L                               | L               | Current Burst Address |                  |                      |
| Continue Burst Write | L → H | x               | x                | x   | H                 | H                 | L                | L                               | L               | Next Burst Address    | Din (p)          | N/A                  |
|                      | L → H | H               | x                | x   | L <sup>6</sup>    | H                 | L                | L                               | L               |                       |                  |                      |
| Suspend Burst Write  | L → H | x               | x                | x   | H                 | H                 | H                | L                               | L               | Current Burst Address | Din (p)          | N/A                  |
|                      | L → H | H               | x                | x   | L <sup>6</sup>    | H                 | H                | L                               | L               |                       |                  |                      |
| Deselected           | L → H | H               | x                | x   | x                 | L                 | x                | x                               | L               | None                  | Hi - Z (p)       | I <sub>DDS2</sub>    |
|                      | L → H | L               | H                | x   | L                 | x                 | x                | x                               | L               |                       |                  |                      |
|                      | L → H | L               | x                | L   | L                 | x                 | x                | x                               | L               |                       |                  |                      |
|                      | L → H | L               | H                | x   | H                 | L                 | x                | x                               | L               |                       |                  |                      |
|                      | L → H | L               | x                | L   | H                 | L                 | x                | x                               | L               |                       |                  |                      |
| Snooze               | L → H | x               | x                | x   | x                 | x                 | x                | x                               | H               | None                  | Hi - Z (p)       | I <sub>DDS3</sub>    |

Note: 1. ZZ input, although asynchronous, is included in this table.

2. Consumption current does not include output buffer current.

3. H means logical High and L means logical Low. x means Don't Care.

4.  $\overline{WRITE} = L$  means any one or more of the byte write enable inputs ( $\overline{BW1}$ ,  $\overline{BW2}$ ,  $\overline{BW3}$ ,  $\overline{BW4}$ ) and  $\overline{BWE}$  are Low, or that  $\overline{GW}$  is Low.  $\overline{WRITE} = H$  means  $\overline{GW}$  and  $\overline{BWE}$  are High, or  $\overline{GW}$  is High and  $\overline{BWE}$  is Low and all byte write enable inputs are High.

5. (n) and (p) indicate the cycles affected by the synchronous control inputs. (n) is the next cycle, (p) is the present cycle.

6. When  $\overline{CE} = H$ ,  $\overline{ADSP}$  is disabled ( $\overline{ADSP} = X$ ).  $\overline{ADSP} = L$  to avoid redundancy with the previous truth table entry when  $\overline{CE} = H$  and  $\overline{ADSP} = H$ .

## (2) Partial Truth Table for Write Enables (Synchronous Input)

| OPERATION | CLK   | $\overline{GW}$ | $\overline{BWE}$ | $\overline{BW1}$                                                                                                                                                                                                                                                 | $\overline{BW2}$ | $\overline{BW3}$ | $\overline{BW4}$ | I/O1 to I/O8 | I/O9 to I/O16 | I/O17 to I/O24 | I/O25 to I/O32 |
|-----------|-------|-----------------|------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|------------------|------------------|--------------|---------------|----------------|----------------|
| Read      | L → H | H               | H                | x                                                                                                                                                                                                                                                                | x                | x                | x                | Dout (p)     | Dout (p)      | Dout (p)       | Dout (p)       |
|           | L → H | H               | L                | H                                                                                                                                                                                                                                                                | H                | H                | H                | Dout (p)     | Dout (p)      | Dout (p)       | Dout (p)       |
| Write     | L → H | L               | x                | x                                                                                                                                                                                                                                                                | x                | x                | x                | Din (p)      | Din (p)       | Din (p)        | Din (p)        |
|           |       | H               | L                | L                                                                                                                                                                                                                                                                | L                | L                | L                | Din (p)      | Din (p)       | Din (p)        | Din (p)        |
|           |       | H               | L                | L                                                                                                                                                                                                                                                                | H                | H                | H                | Din (p)      | Hi - Z (p)    | Hi - Z (p)     | Hi - Z (p)     |
|           |       |                 |                  | H                                                                                                                                                                                                                                                                | L                | H                | H                | Hi - Z (p)   | Din (p)       | Hi - Z (p)     | Hi - Z (p)     |
|           |       |                 |                  | H                                                                                                                                                                                                                                                                | H                | L                | H                | Hi - Z (p)   | Hi - Z (p)    | Din (p)        | Hi - Z (p)     |
|           |       |                 |                  | H                                                                                                                                                                                                                                                                | H                | H                | L                | Hi - Z (p)   | Hi - Z (p)    | Hi - Z (p)     | Din (p)        |
|           |       |                 |                  | The other 11 combinations of $\overline{BW1}$ to $\overline{BW4}$ are also effective.<br>$\overline{BW1}$ controls I/O1 to I/O8. $\overline{BW2}$ controls I/O9 to I/O16.<br>$\overline{BW3}$ controls I/O17 to I/O24. $\overline{BW4}$ controls I/O25 to I/O32. |                  |                  |                  |              |               |                |                |
|           |       |                 |                  |                                                                                                                                                                                                                                                                  |                  |                  |                  |              |               |                |                |
|           |       |                 |                  |                                                                                                                                                                                                                                                                  |                  |                  |                  |              |               |                |                |
|           |       |                 |                  |                                                                                                                                                                                                                                                                  |                  |                  |                  |              |               |                |                |
|           |       |                 |                  |                                                                                                                                                                                                                                                                  |                  |                  |                  |              |               |                |                |
|           |       |                 |                  |                                                                                                                                                                                                                                                                  |                  |                  |                  |              |               |                |                |

Note : 1. (n) and (p) indicate the cycles affected by the synchronous control inputs. (n) is the next cycle, (p) is the present cycle.

## (3) Asynchronous Truth Table

| OPERATION  | $\overline{OE}$ | ZZ | I/O1 to I/O32 |
|------------|-----------------|----|---------------|
| Read       | L               | L  | Dout          |
|            | H               | L  | Hi - Z        |
| Write      | x               | L  | Din, Hi - Z   |
| Deselected | x               | L  | Hi - Z        |
| Snooze     | x               | H  | Hi - Z        |

(4) Interleaved Burst Sequence (MODE Input=NC or V<sub>DD</sub>)

Bit Order : A<sub>16</sub> A<sub>13</sub> ..... A<sub>3</sub> A<sub>2</sub> A<sub>1</sub> A<sub>0</sub>  
The lower 2 bits are internally generated from the external address.

| 1st Address<br>(External) | 2nd Address<br>(Internal) | 3rd Address<br>(Internal) | 4th Address<br>(Internal) |
|---------------------------|---------------------------|---------------------------|---------------------------|
| XX ..... XX00             | XX ..... XX01             | XX ..... XX10             | XX ..... XX11             |
| XX ..... XX01             | XX ..... XX00             | XX ..... XX11             | XX ..... XX10             |
| XX ..... XX10             | XX ..... XX11             | XX ..... XX00             | XX ..... XX01             |
| XX ..... XX11             | XX ..... XX10             | XX ..... XX01             | XX ..... XX00             |

The burst address wraps around to its initial state.

(5) Linear Burst Sequence (MODE Input=V<sub>SS</sub>)

Bit Order : A<sub>16</sub> A<sub>13</sub> ..... A<sub>3</sub> A<sub>2</sub> A<sub>1</sub> A<sub>0</sub>  
The lower 2 bits are internally generated from the external address.

| 1st Address<br>(External) | 2nd Address<br>(Internal) | 3rd Address<br>(Internal) | 4th Address<br>(Internal) |
|---------------------------|---------------------------|---------------------------|---------------------------|
| XX ..... XX00             | XX ..... XX01             | XX ..... XX10             | XX ..... XX11             |
| XX ..... XX01             | XX ..... XX10             | XX ..... XX11             | XX ..... XX00             |
| XX ..... XX10             | XX ..... XX11             | XX ..... XX00             | XX ..... XX01             |
| XX ..... XX11             | XX ..... XX00             | XX ..... XX01             | XX ..... XX10             |

The burst address wraps around to its initial state.



## (6) Stop-Clock Mode for Power Down

The TC55V4336FFI achieves low power standby mode by stopping the clock input. It can retain all state and data values even though the clock is not running.

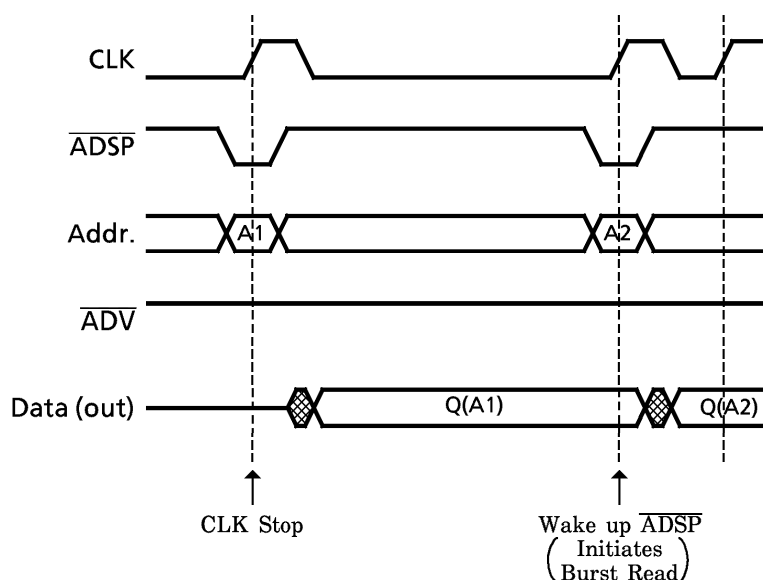
To achieve the lowest possible power operation, the following signal states are required.

- i) Clock is Low
- ii) Control signals are inactive (for example,  $\overline{\text{ADSP}}$  is High)

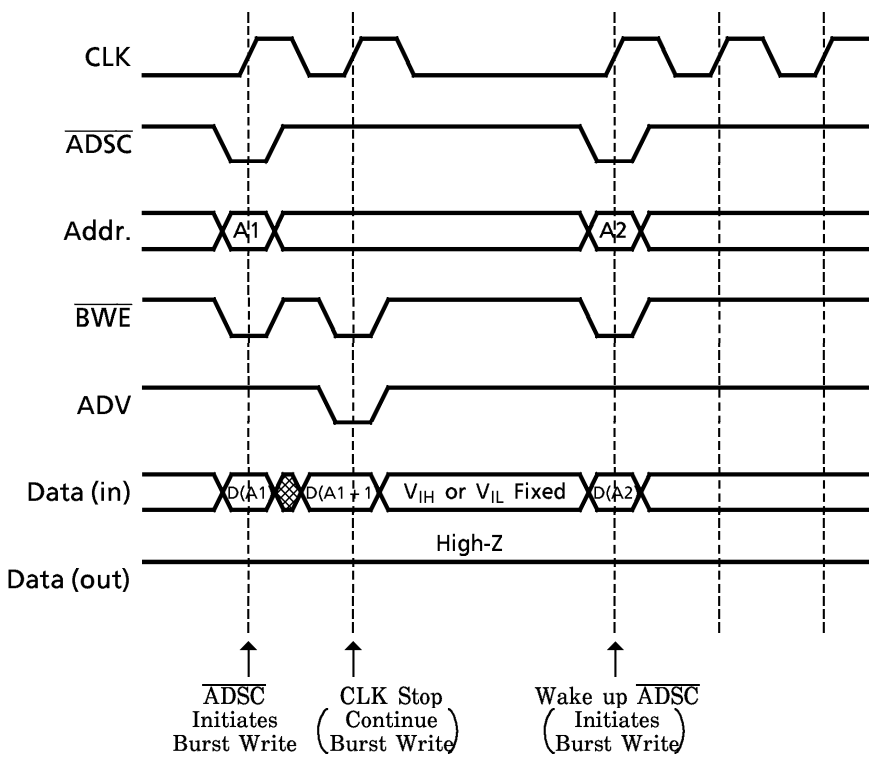
For the lowest possible power consumption during stop-clock mode, the address inputs should be driven to MOS level ( $V_{IH} \geq V_{DD} - 0.2 \text{ V}$  or  $V_{IL} \leq 0.2 \text{ V}$ ), and the data inputs should be driven to MOS low level ( $V_{IL} \leq 0.2 \text{ V}$ ).

· Clock restart sequence

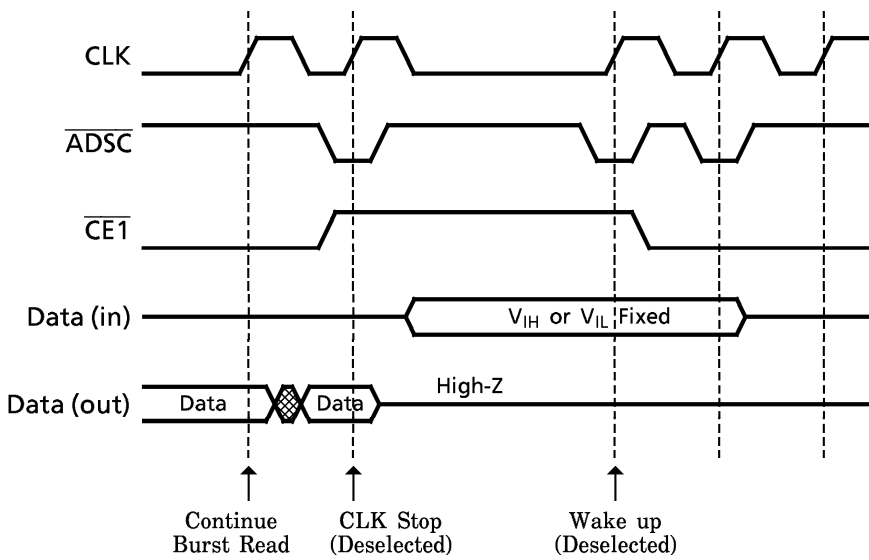
The device can be waked up by the first rising edge of the clock signal after having been in power down mode.



i) Stop-Clock Timing for Read Operation



ii) Stop-Clock Timing for Write Operation



iii) Stop-Clock Timing for Deselect Operation

**MAXIMUM RATINGS**

| SYMBOL       | RATING                             | VALUE                         | UNIT |
|--------------|------------------------------------|-------------------------------|------|
| $V_{DD}$     | Power Supply Voltage               | -0.5 to 4.6                   | V    |
| $V_{DDQ}$    | Output Buffer Power Supply Voltage | -0.5 to $V_{DD}$              | V    |
| $V_{IN}$     | Input Terminal Voltage             | -0.5* to 4.6                  | V    |
| $V_{I/O}$    | Input/Output Terminal Voltage      | -0.5* to $V_{DDQ} + 0.5^{**}$ | V    |
| $P_D$        | Power Dissipation                  | 1.2                           | W    |
| $T_{solder}$ | Soldering Temperature (10 s)       | 260                           | °C   |
| $T_{strg}$   | Storage Temperature                | -65 to 150                    | °C   |
| $T_{opr}$    | Operating Temperature              | -40 to 85                     | °C   |

\* : -1.5V with a pulse width of 20% ·  $t_{KC}$  min

\*\* :  $V_{DDQ} + 1.5V$  with a pulse width of 20% ·  $t_{KC}$  min

**DC RECOMMENDED OPERATING CONDITIONS ( $T_a = -40^\circ$  to  $85^\circ C$ )**

| SYMBOL    | PARAMETER                                                                 | MIN            | TYP      | MAX                  | UNIT |
|-----------|---------------------------------------------------------------------------|----------------|----------|----------------------|------|
| $V_{DD}$  | Power Supply Voltage                                                      | 3.1            | 3.3      | 3.6                  | V    |
| $V_{DDQ}$ | Output Buffer Power Supply Voltage                                        | 2.3            | –        | 3.6                  | V    |
| $V_{IH}$  | Input High Voltage for Address and Control pins (except I/O and Mode pin) | 1.7            | –        | $V_{DD} + 0.3$       | V    |
|           | Input High Voltage for I/O pins                                           | 1.7            | –        | $V_{DDQ} + 0.3^{**}$ |      |
| $V_{IH1}$ | Input High Voltage for MODE pin                                           | $V_{DD} - 0.3$ | $V_{DD}$ | $V_{DD} + 0.3$       | V    |
| $V_{IL}$  | Input Low Voltage                                                         | -0.3*          | –        | 0.7                  | V    |
| $V_{IL1}$ | Input Low Voltage for MODE and NU pins                                    | -0.3           | 0.0      | 0.3                  | V    |

\* : -1.0V with a pulse width of 20% ·  $t_{KC}$  min

\*\* :  $V_{DDQ} + 1.0V$  with a pulse width of 20% ·  $t_{KC}$  min

Note: NU pin must be low or not connected.

You must not apply a voltage of more than 0.8 V to the NU.

**DC CHARACTERISTICS** ( $T_a = -40^\circ$  to  $85^\circ\text{C}$ ,  $V_{DD} = 3.1\text{V}$  to  $3.6\text{V}$ ,  $V_{DDQ} = 2.3\text{V}$  to  $2.7\text{V}$  or  $3.1\text{V}$  to  $3.6\text{V}$ )

| SYMBOL            | PARAMETER                                           |                                   | TEST CONDITION                                                                                                                                             | MIN                    | TYP | MAX | UNIT |
|-------------------|-----------------------------------------------------|-----------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------|-----|-----|------|
| I <sub>IL</sub>   | Input Leakage Current<br>(Except MODE, ZZ, NU pins) |                                   | V <sub>IN</sub> = 0 to V <sub>DD</sub>                                                                                                                     | –                      | –   | ± 1 | μA   |
| I <sub>LO</sub>   | Output Leakage Current                              |                                   | Device Deselected or<br>Output Deselected,<br>V <sub>OUT</sub> = 0 to V <sub>DD</sub>                                                                      | –                      | –   | ± 1 | μA   |
| I <sub>I</sub>    | Input Current                                       | MODE pin                          | V <sub>IN</sub> = V <sub>DD</sub> to V <sub>DD</sub> – 0.3V                                                                                                | – 1                    | –   | 1   | μA   |
|                   |                                                     |                                   | V <sub>IN</sub> = 0 to 0.3V                                                                                                                                | – 100                  | –   | 1   |      |
|                   |                                                     | ZZ pin                            | V <sub>IN</sub> = V <sub>DD</sub> to 2.0V                                                                                                                  | – 1                    | –   | 100 |      |
|                   |                                                     |                                   | V <sub>IN</sub> = 0 to 0.8V                                                                                                                                | – 1                    | –   | 20  |      |
|                   |                                                     |                                   | V <sub>IN</sub> = 0 to 0.3V                                                                                                                                | – 1                    | –   | 1   |      |
|                   |                                                     | NU pin                            | V <sub>IN</sub> = 0 to 0.3V                                                                                                                                | – 1                    | –   | 1   |      |
| V <sub>OH</sub>   | Output High Voltage                                 | V <sub>DDQ</sub><br>= 3.1 to 3.6V | I <sub>OH</sub> = – 8mA                                                                                                                                    | 2.4                    | –   | –   | V    |
|                   |                                                     |                                   | I <sub>OH</sub> = – 100μA                                                                                                                                  | V <sub>DDQ</sub> – 0.2 | –   | –   |      |
|                   |                                                     | V <sub>DDQ</sub><br>= 2.3 to 2.7V | I <sub>OH</sub> = – 2mA                                                                                                                                    | 1.9                    | –   | –   |      |
|                   |                                                     |                                   | I <sub>OH</sub> = – 100μA                                                                                                                                  | V <sub>DDQ</sub> – 0.2 | –   | –   |      |
| V <sub>OL</sub>   | Output Low Voltage                                  | V <sub>DDQ</sub><br>= 3.1 to 3.6V | I <sub>OL</sub> = 8mA                                                                                                                                      | –                      | –   | 0.4 |      |
|                   |                                                     |                                   | I <sub>OL</sub> = 100μA                                                                                                                                    | –                      | –   | 0.2 |      |
|                   |                                                     | V <sub>DDQ</sub><br>= 2.3 to 2.7V | I <sub>OL</sub> = 2mA                                                                                                                                      | –                      | –   | 0.4 |      |
|                   |                                                     |                                   | I <sub>OL</sub> = 100μA                                                                                                                                    | –                      | –   | 0.2 |      |
| I <sub>DDO1</sub> | Operating Current                                   |                                   | Device Selected, I <sub>out</sub> = 0mA<br>All inputs = V <sub>IH</sub> / V <sub>IL</sub><br>CLK ≥ t <sub>KC</sub> min                                     | –                      | –   | 300 | mA   |
| I <sub>DDO2</sub> | Operating Current<br>(Idle)                         |                                   | Device Selected, I <sub>out</sub> = 0mA<br>ADSC, ADSP, ADV ≥ V <sub>IH</sub><br>All inputs = V <sub>IH</sub> / V <sub>IL</sub> , CLK ≥ t <sub>KC</sub> min | –                      | –   | 270 | mA   |
| I <sub>DDS1</sub> | Standby Current<br>(CLK running)                    |                                   | Device Deselected,<br>All inputs ≤ V <sub>IH</sub> / V <sub>IL</sub><br>CLK ≥ t <sub>KC</sub> min                                                          | –                      | –   | 80  | mA   |
| I <sub>DDS2</sub> | Standby Current                                     |                                   | Device Deselected,<br>All inputs ≤ V <sub>DD</sub> – 0.2V or 0.2V,<br>CLK frequency = 0Hz                                                                  | –                      | –   | 3   | mA   |
| I <sub>DDS3</sub> | Snooze Current while ZZ Pin is High                 |                                   | ZZ = V <sub>DD</sub> – 0.2V,<br>All inputs = V <sub>IH</sub> / V <sub>IL</sub><br>CLK ≥ t <sub>KC</sub> min                                                | –                      | –   | 3   | mA   |
| I <sub>DDS4</sub> | Snooze Current during Stop-Clock Mode               |                                   | ZZ ≤ 0.2V, Chip Deselected<br>CLK ≤ 0.2V, ADSP, ADSC = V <sub>DD</sub> – 0.2V<br>All inputs ≤ 0.2V                                                         | –                      | –   | 3   | mA   |

**CAPACITANCE** ( $T_a = 25^\circ\text{C}$ ,  $f = 1.0\text{MHz}$ )

| SYMBOL    | PARAMETER                              | TEST CONDITION         | MAX | UNIT |
|-----------|----------------------------------------|------------------------|-----|------|
| $C_{IN}$  | Input Capacitance                      | $V_{IN} = \text{GND}$  | 5   | pF   |
|           | Input Capacitance for MODE, ZZ, NU pin | $V_{IN} = \text{GND}$  | 8   | pF   |
| $C_{I/O}$ | Input/Output Capacitance               | $V_{I/O} = \text{GND}$ | 6   | pF   |

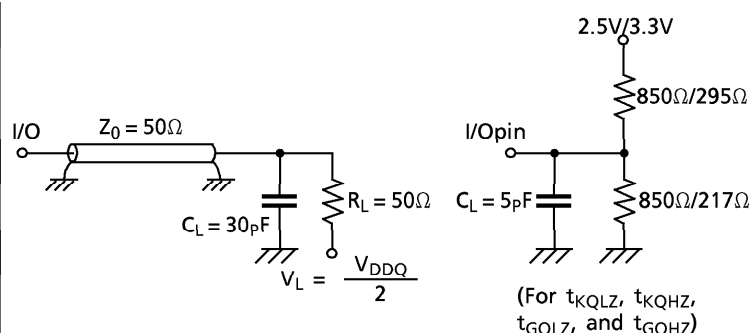
Note: This parameter is periodically sampled and is not 100% tested.

**AC CHARACTERISTICS** ( $T_a = -40^\circ$  to  $85^\circ\text{C}$ ,  $V_{DD} = 3.1\text{V}$  to  $3.6\text{V}$ ,  $V_{DDQ} = 2.3\text{V}$  to  $2.7\text{V}$  or  $3.1\text{V}$  to  $3.6\text{V}$ )

| SYMBOL     | PARAMETER                                                                                           | TC55V4336FFI-83 |     | UNIT  |
|------------|-----------------------------------------------------------------------------------------------------|-----------------|-----|-------|
|            |                                                                                                     | MIN             | MAX |       |
| $t_{KC}$   | CLK Cycle Time                                                                                      | 12              | –   | ns    |
| $t_{KH}$   | CLK High Pulse Width                                                                                | 4.5             | –   |       |
| $t_{KL}$   | CLK Low Pulse Width                                                                                 | 4.5             | –   |       |
| $t_{KQV}$  | Access Time from CLK                                                                                | –               | 9   |       |
| $t_{KQX}$  | Output Hold Time from CLK                                                                           | 2               | –   |       |
| $t_{KQLZ}$ | Output Enable Time from CLK                                                                         | 0               | –   |       |
| $t_{KQHZ}$ | Output Disable Time from CLK                                                                        | 2               | 3.5 |       |
| $t_{GQV}$  | Access Time from $\overline{OE}$                                                                    | –               | 3.5 |       |
| $t_{GQLZ}$ | Output Enable Time from $\overline{OE}$                                                             | 0               | –   |       |
| $t_{GQHZ}$ | Output Disable Time from $\overline{OE}$                                                            | –               | 3.5 |       |
| $t_{AS}$   | Address Input Setup Time from CLK                                                                   | 2               | –   |       |
| $t_{AH}$   | Address Input Hold Time from CLK                                                                    | 0.5             | –   |       |
| $t_{ADSS}$ | $\overline{ADSP}$ , $\overline{ADSC}$ Input Setup Time from CLK                                     | 2               | –   |       |
| $t_{ADSH}$ | $\overline{ADSP}$ , $\overline{ADSC}$ Input Hold Time from CLK                                      | 0.5             | –   |       |
| $t_{AVS}$  | $\overline{ADV}$ Input Setup Time from CLK                                                          | 2               | –   |       |
| $t_{AVH}$  | $\overline{ADV}$ Input Hold Time from CLK                                                           | 0.5             | –   |       |
| $t_{WS}$   | $\overline{GW}$ , $\overline{BWE}$ , $\overline{BW1}$ to $\overline{BW4}$ Input Setup Time from CLK | 2               | –   |       |
| $t_{WH}$   | $\overline{GW}$ , $\overline{BWE}$ , $\overline{BW1}$ to $\overline{BW4}$ Input Hold Time from CLK  | 0.5             | –   |       |
| $t_{CES}$  | $\overline{CE}$ , $\overline{CE2}$ , $\overline{CE2}$ Input Setup Time from CLK                     | 2               | –   |       |
| $t_{CEH}$  | $\overline{CE}$ , $\overline{CE2}$ , $\overline{CE2}$ Input Hold Time from CLK                      | 0.5             | –   |       |
| $t_{DS}$   | Data Setup Time from CLK                                                                            | 2               | –   |       |
| $t_{DH}$   | Data Hold Time from CLK                                                                             | 0.5             | –   |       |
| $t_{ZS}$   | ZZ Standby Time                                                                                     | 5               | –   |       |
| $t_{ZR}$   | ZZ Recovery Time                                                                                    | 6               | –   |       |
| $t_{ZHZ}$  | Output Disable Time from ZZ                                                                         | –               | 2   | cycle |

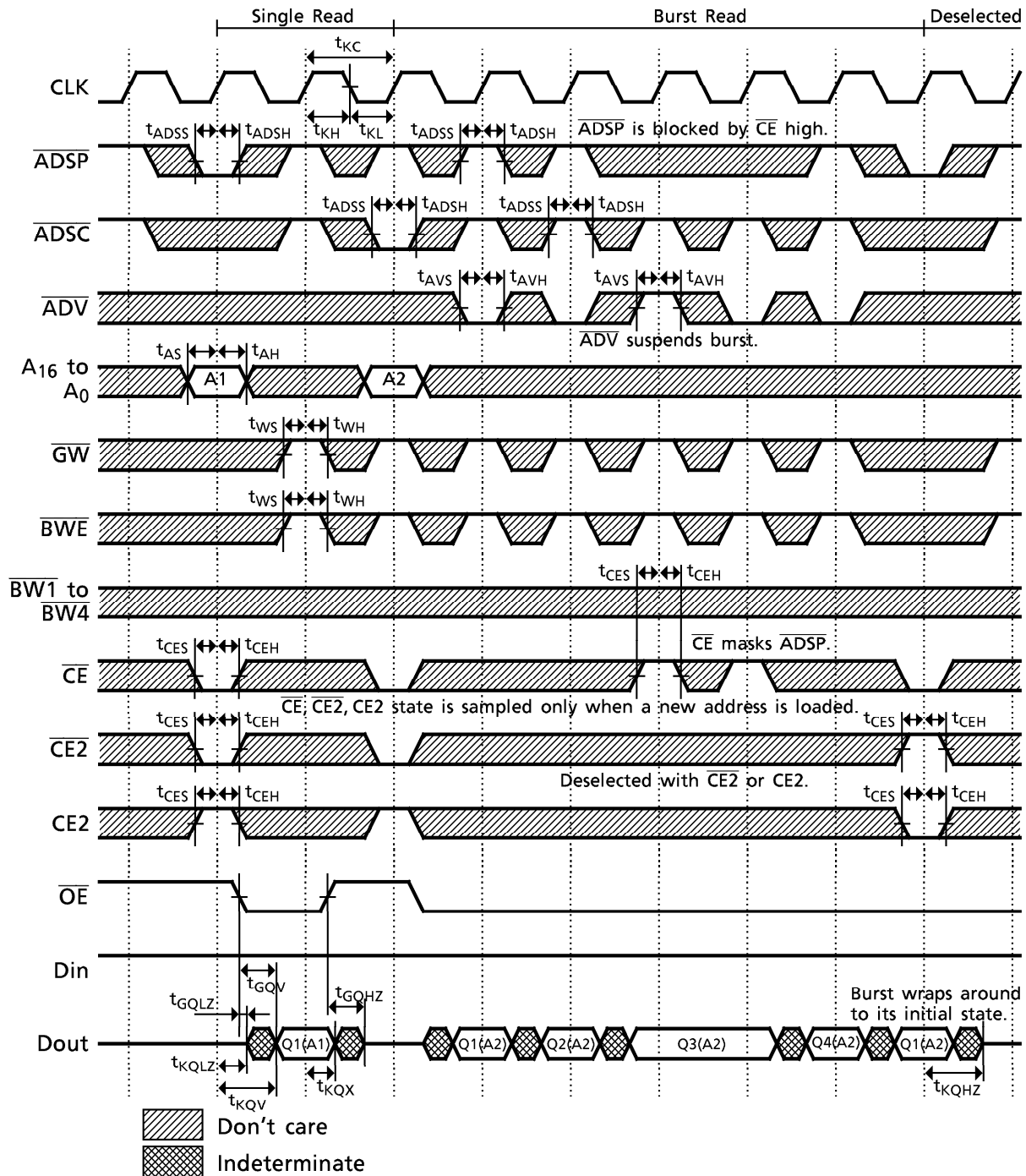
**AC TEST CONDITIONS**

|                                           | $V_{DDQ} = 2.5\text{V}$ | $V_{DDQ} = 3.3\text{V}$ |
|-------------------------------------------|-------------------------|-------------------------|
| Input Pulse Level                         | 2.5V/0.0V               | 3.0V/0.0V               |
| Input Pulse Rise and Fall Time            | 1.8ns                   | 2.0ns                   |
| Input Timing Measurement Reference Level  | 1.25V                   | 1.5V                    |
| Output Timing Measurement Reference Level | $\frac{V_{DDQ}}{2}$     | $\frac{V_{DDQ}}{2}$     |
| Output Load                               | Fig. 1                  | Fig. 1                  |

**Fig. 1**

## TIMING DIAGRAMS

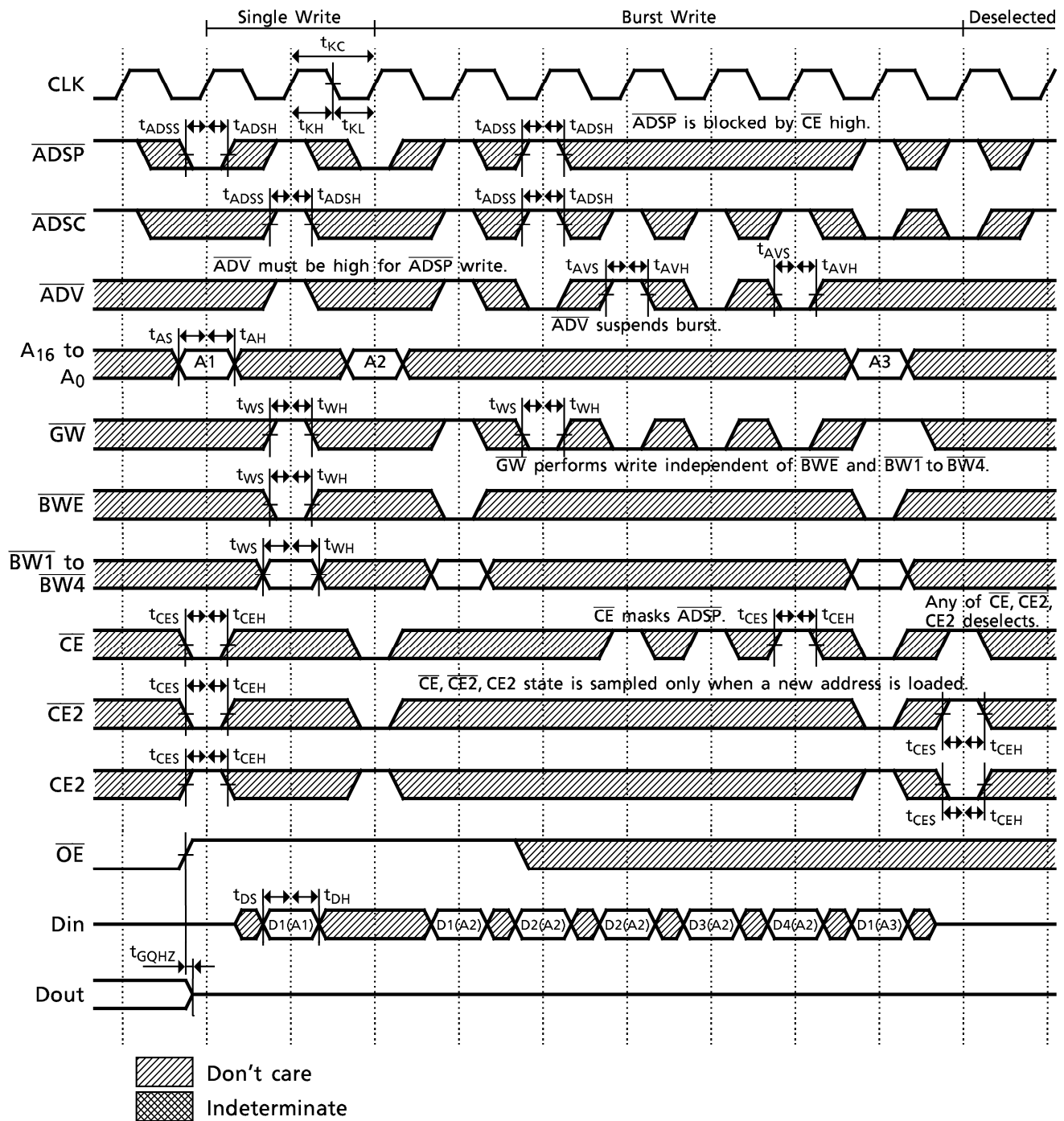
## READ CYCLE



## Note

1. Q1(A2) represents output data from 1st burst address starting from address A2. Q2(A2) represents output data from 2nd burst address starting from address A2.
2. ZZ is Low.

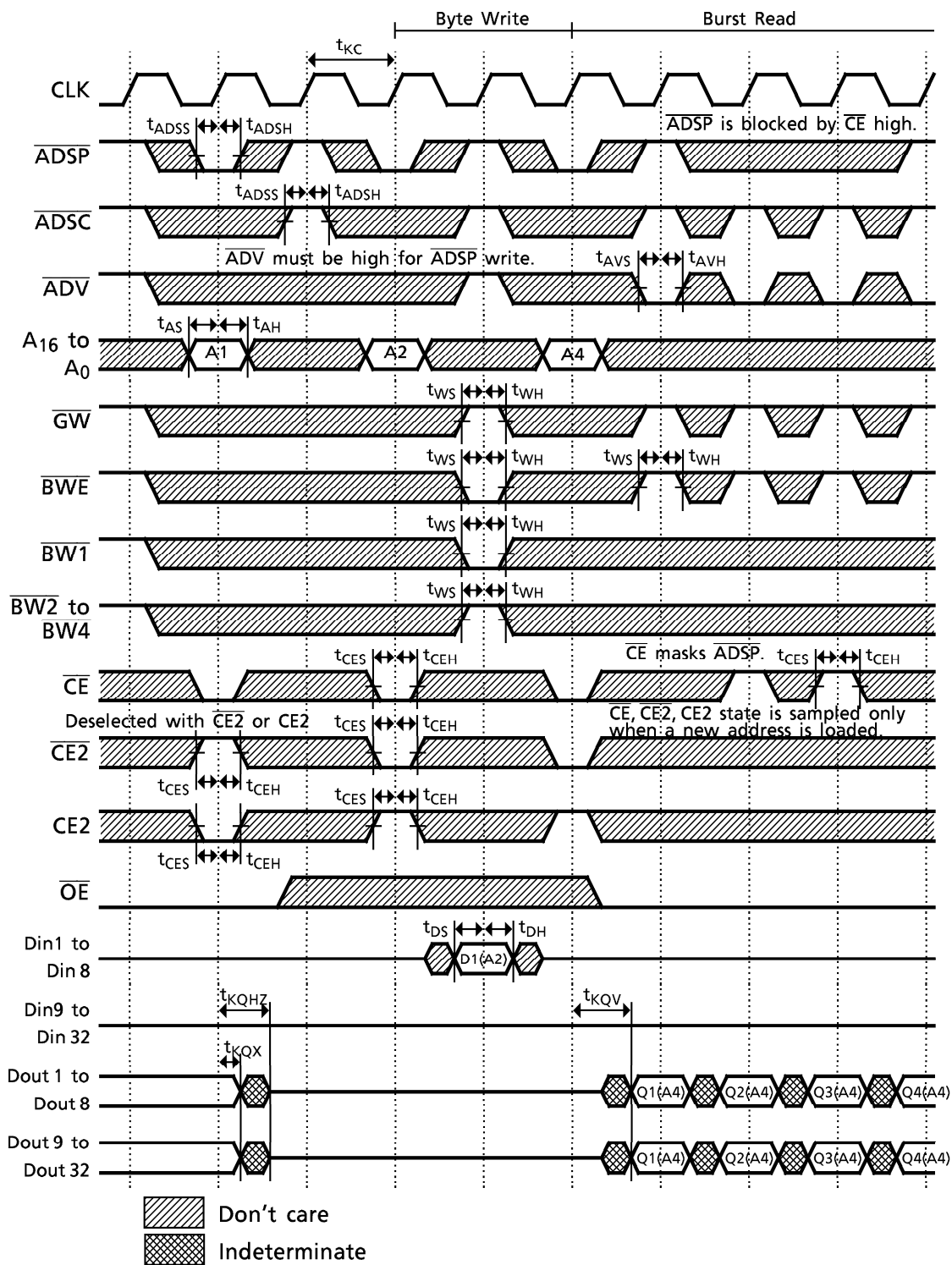
## WRITE CYCLE



## Note

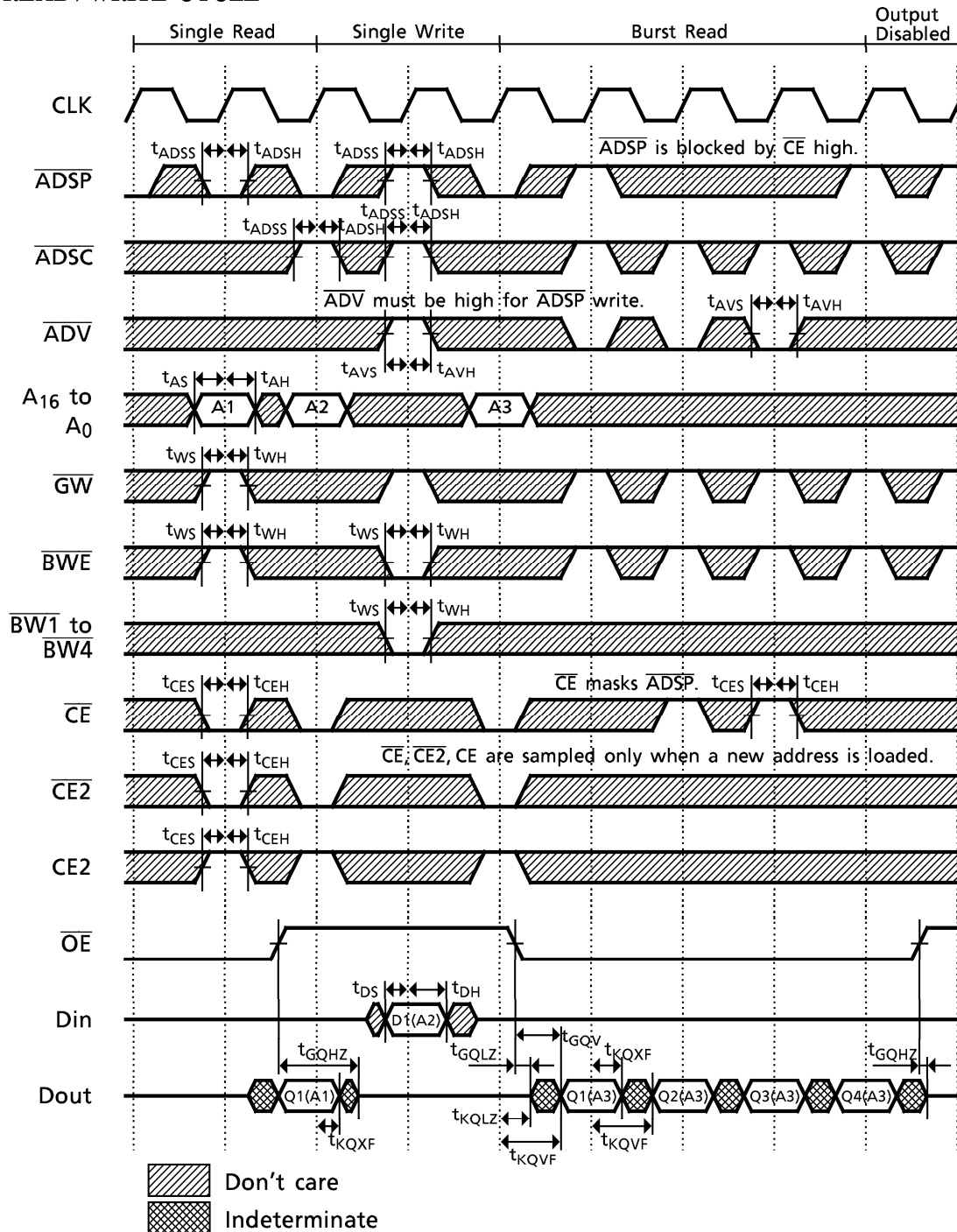
1. D1(A2) represents input data for 1st burst address starting from address A2. D2(A2) represents input data for 2nd burst address starting from address A2.
2. ZZ is Low.

## WRITE CYCLE (BYTE WRITE TIMING)





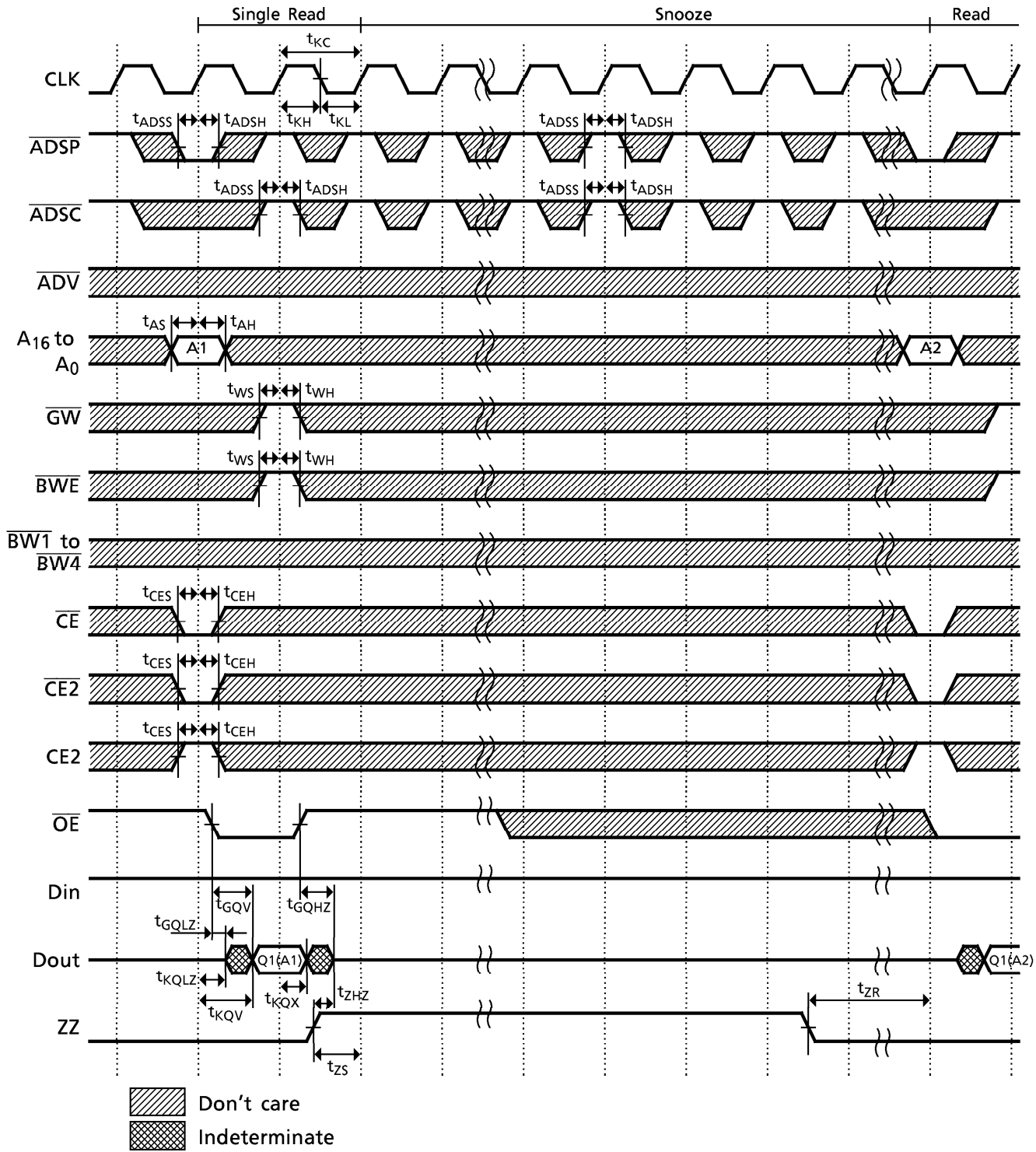
## READ / WRITE CYCLE



## Note

1. When a write operation follows a read operation,  $\overline{OE}$  must be driven high prior to the assertion of the byte write enables ( $\overline{GW}$ ,  $\overline{BWE}$ ,  $\overline{BW1}$  to  $\overline{BW4}$ ) and before input data is applied to avoid data bus contention.
2. ZZ is Low.

SNOOZE CYCLE



2. Output enable and output disable times are specified as follows using the output load shown in Fig. 1.

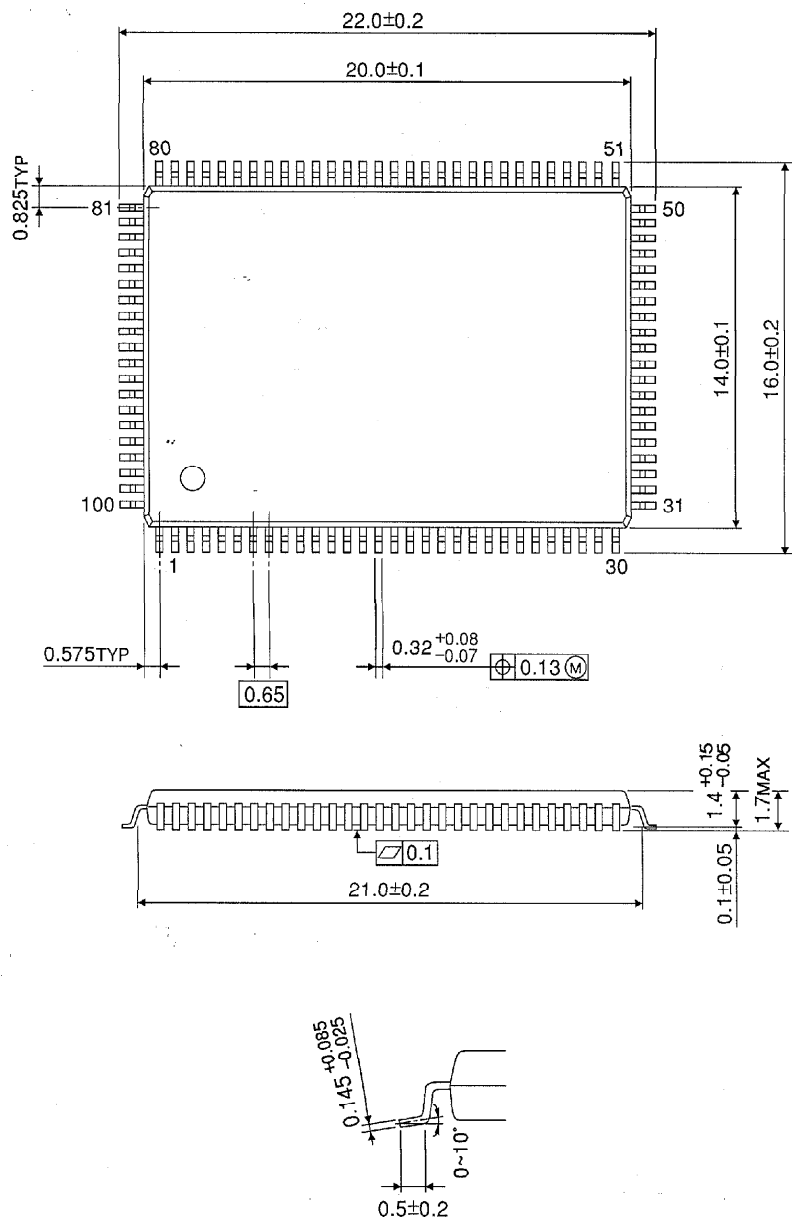
Timing diagram for ADSP and ADSC signals. The diagram shows the relationship between CLK, ADSP, ADSC, and DOUT signals. ADSP and ADSC are active-low signals. DOUT is a bidirectional signal. The diagram includes timing parameters  $t_{KQLZ}$  and  $t_{KQHZ}$ , and a note (See Note 2).

1. Input states are defined in the Synchronous Input Truth Table.
2. When the device is deselected, the output goes into a high impedance state in the present clock cycle regardless of  $\overline{\text{OE}}$ .

PACKAGE DIMENSIONS

Plastic LQFP (LQFP100-P-1420-0.65K)

Unit in mm



Weight: 0.56 g (typ)